

Appl. No. Serial No. 09/714,680
Amdt. dated May 31, 2007
Reply to Office action of December 01, 2006

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. for Reissue No. : 09/714,680
Patent No. : 6,054,198
Applicant : Bunyan *et al.*
Filed : November 16, 2000
Title : Conformal Thermal Interface
Material For Electronic Components

TC/A.U. : 1773
Examiner : D. L. Tarazano

Docket No. : 2802-257-006

Honorable Commissioner For Patents
Alexandria, VA 22313-1450

AMENDMENT

In response to the Office action of December 01, 2006, reconsideration of the identified application is respectfully requested:

Remarks begin on page 2 of this paper.